



WANSEMI
万芯半导体

WP12N65FA

Enhancement Mode N-Channel Power MOSFET

TO-220F/NMOS/650V/ ± 30 V/3V/12A/610m Ω

Rev0.7

Enhancement Mode N-Channel Power MOSFET

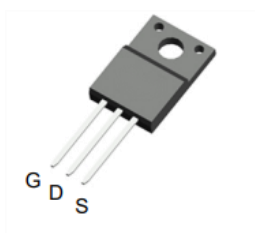
1.Features

- ◆ Fast Switching
- ◆ Improved dv/dt Capability

| V_{DS} | $R_{DS(on)}$ Typ. | I_D Max. |
|----------|-------------------|------------|
| 650V | 610mΩ @ 10V | 12A |

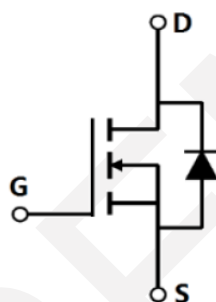
2.Applications

- ◆ Load Switch
- ◆ PWM Application
- ◆ Power management



Pin Description

TO-220F



Schematic

3.Package Marking and Ordering Information

| Part no. | Marking | Package | PCS/Tube | PCS/CTN. |
|-----------|---------|---------|----------|----------|
| WP12N65FA | WP12N65 | TO-220F | 50 | 5,000 |

4.Absolute Max Ratings at Ta=25°C (Note1)

| Parameter | Symbol | Value | Units |
|---|-----------|-------------|-------|
| Drain to Source Voltage | V_{DS} | 650 | V |
| Gate to Source Voltage | V_{GS} | ±30 | V |
| Drain Current (DC) | I_D | 12 | A |
| Drain Current (Pulse), $PW \leq 300\mu s$ | I_{DP} | 48 | A |
| Total Dissipation | P_D | 31 | W |
| Avalanche Energy, Single Pulsed | E_{AS} | 281 | mJ |
| Junction Temperature | T_j | 150 | °C |
| Storage Temperature | T_{stg} | -55 to +150 | °C |

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

5. Thermal Resistance Ratings

| Parameter | Symbol | Value | Unit |
|---------------------|-----------------|-------|----------------------|
| Junction to case | $R_{\theta JC}$ | 3.5 | $^{\circ}\text{C/W}$ |
| Junction to ambient | $R_{\theta JA}$ | 55 | $^{\circ}\text{C/W}$ |

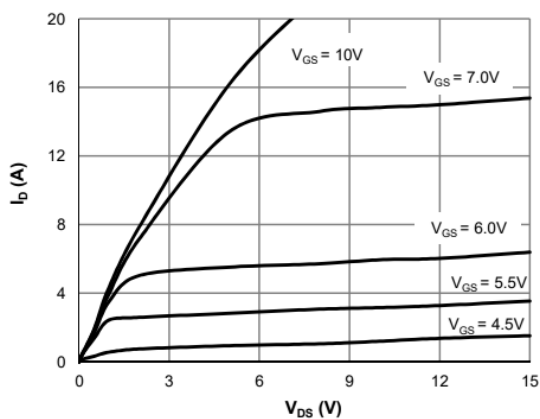
Note 2: When mounted on 1 inch square copper board $t \leq 10\text{sec}$ The value in any given application depends on the user's specific board design.

6. Electrical Characteristics at $T_a=25^{\circ}\text{C}$ (Note 3)

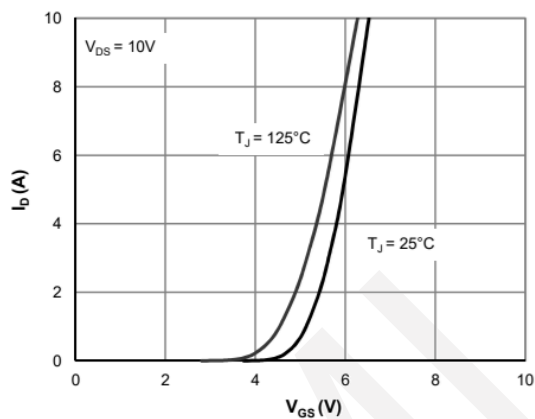
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Units |
|--|---------------|--|------|------|-----------|----------|
| Drain to Source Breakdown Voltage | $V_{(BR)DSS}$ | $I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$ | 650 | | | V |
| Zero-Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 650\text{V}$, $V_{GS} = 0\text{V}$ | | | -1 | nA |
| Gate to Source Leakage Current | I_{GSS} | $V_{GS} = \pm 30\text{V}$ | | | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}$, $I_{DS}=250\mu\text{A}$ | 2 | 3 | 4 | V |
| Static Drain to Source On-State Resistance | $R_{DS(on)}$ | $I_D = 6\text{A}$, $V_{GS} = 10\text{V}$ | - | 0.61 | 0.75 | Ω |
| Input Capacitance | C_{iss} | $V_{GS}=0\text{V}$, $V_{DS}=325\text{V}$, Frequency=1.0MHz | | 1056 | | pF |
| Output Capacitance | C_{oss} | | | 31 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 10 | | pF |
| Turn-ON Delay Time | $t_{d(on)}$ | $V_{GS} = 10\text{V}$, $V_{DS} = 325\text{V}$, $R_L = 43\Omega$, $R_{GEN} = 6\Omega$ | | 15.4 | | ns |
| Rise Time | t_r | | | 12 | | ns |
| Turn-OFF Delay Time | $t_{d(off)}$ | | | 58 | | ns |
| Fall Time | t_f | | | 55 | | ns |
| Total Gate Charge | Q_g | $V_{DS} = 325\text{V}$, $V_{GS} = 0 \text{ to } 10\text{V}$, $I_D = 7.5\text{A}$ | | 22 | | nC |
| | Q_{gs} | | | 7.8 | | nC |
| | Q_{gd} | | | 7.2 | | nC |
| Diode Forward Voltage | V_{FSD} | $I_S = 12\text{A}$ | | 0.85 | 1.1 | V |

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

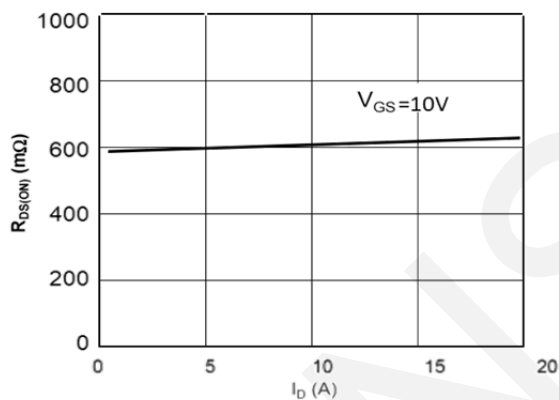
7. Typical electrical and thermal characteristics



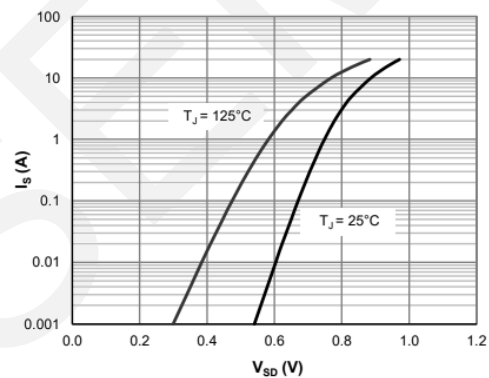
Output Characteristics



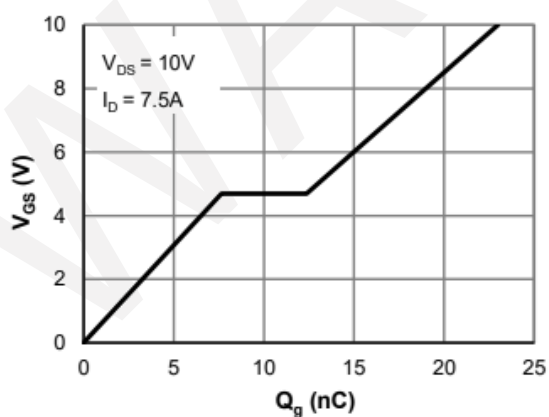
Transfer Characteristics



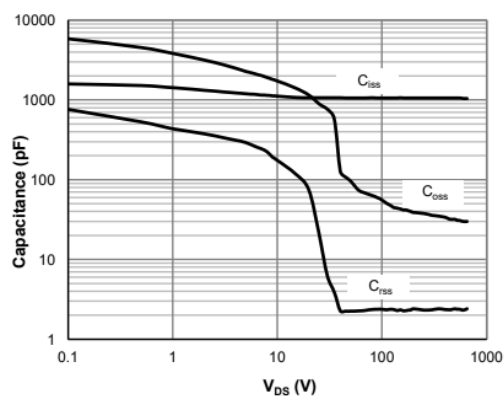
Rdson-Drain Current



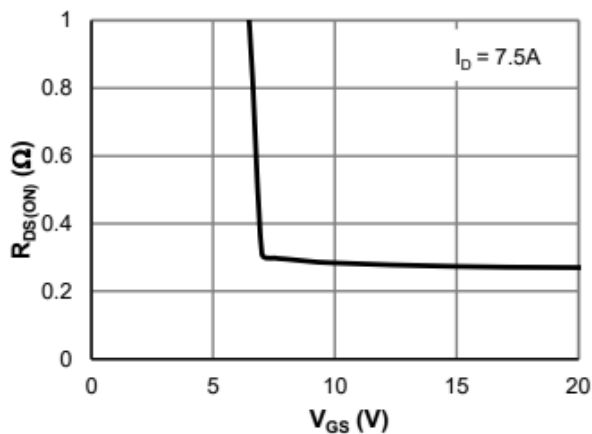
Body Diode Characteristic



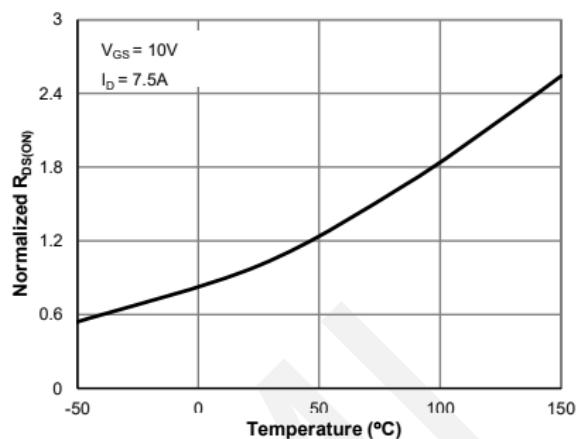
Gate Charge



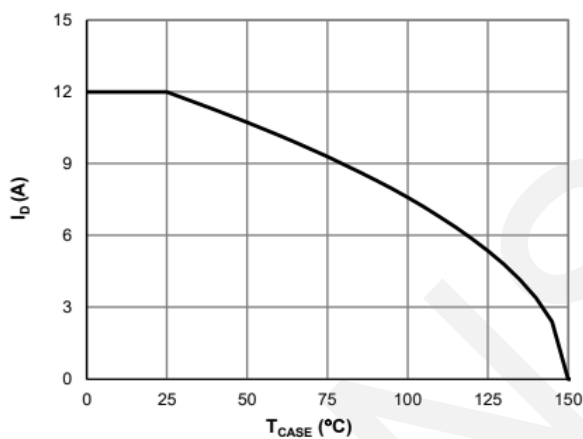
Capacitance Characteristics



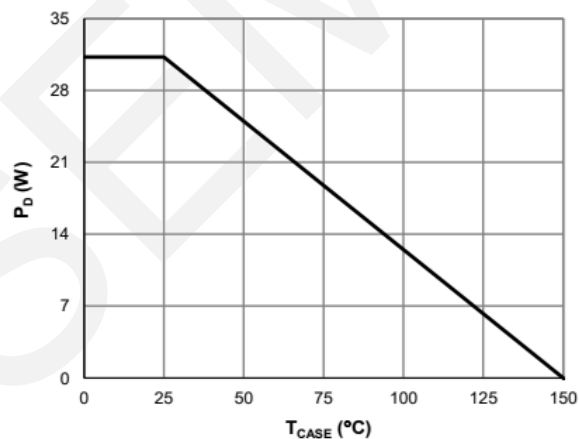
$R_{DS(ON)}$ vs V_{GS}



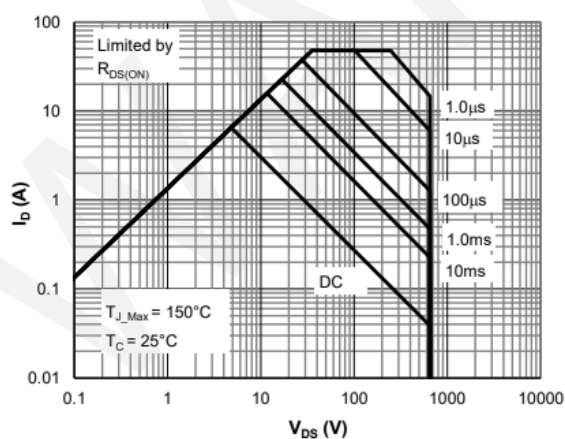
Normalized on Resistance vs.
Junction Temperature



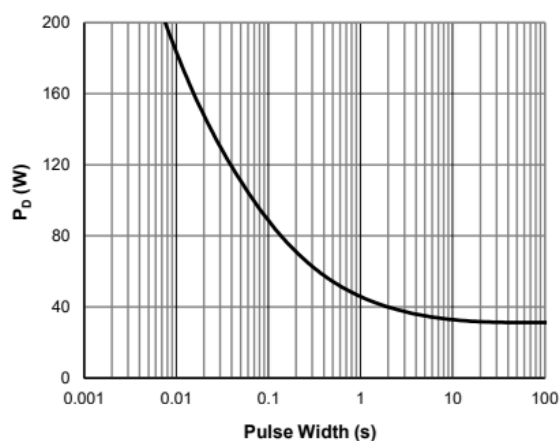
Current De-rating



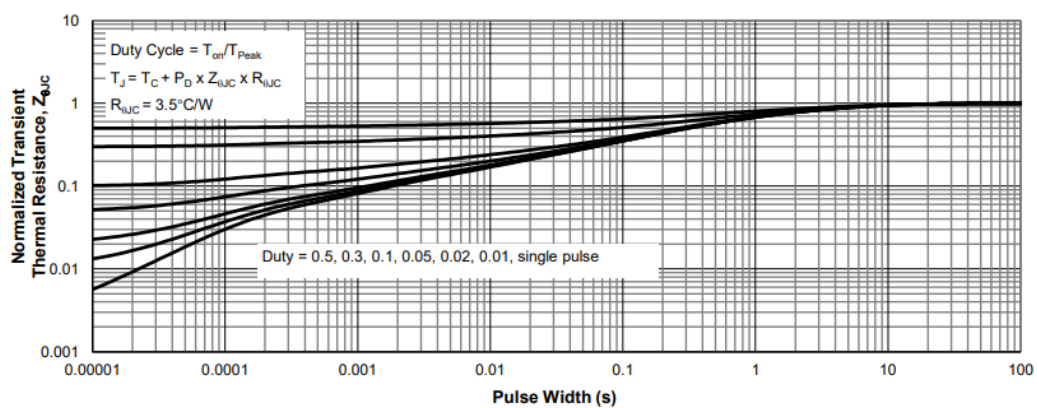
Power De-rating



Maximum Safe Operating Area

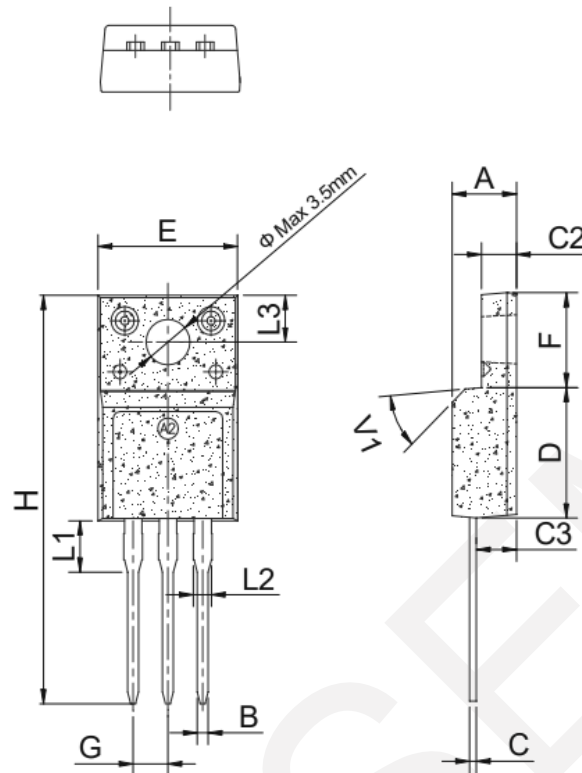


Single Pulse Power Rating,
Junction-to-Case



Normalized Maximum Transient
Thermal Impedance

8.Package Dimensions



| Ref. | Dimensions | | | | | |
|------|-------------|------|------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 4.50 | | 4.90 | 0.177 | | 0.193 |
| B | 0.74 | 0.80 | 0.83 | 0.029 | 0.031 | 0.033 |
| C | 0.47 | | 0.65 | 0.019 | | 0.026 |
| C2 | 2.45 | | 2.75 | 0.096 | | 0.108 |
| C3 | 2.60 | | 3.00 | 0.102 | | 0.118 |
| D | 8.80 | | 9.30 | 0.346 | | 0.366 |
| E | 9.80 | | 10.4 | 0.386 | | 0.410 |
| F | 6.40 | | 6.80 | 0.252 | | 0.268 |
| G | | 2.54 | | | 0.1 | |
| H | 28.0 | | 29.8 | 1.102 | | 1.173 |
| L1 | | 3.63 | | | 0.143 | |
| L2 | 1.14 | | 1.70 | 0.045 | | 0.067 |
| L3 | | 3.30 | | | 0.130 | |
| V1 | | 45° | | | 45° | |

9. Important Notice

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